

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t1020in#pbf

(Engineering Calculation)

PDIP

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TOTAL MASS (g) : 0.987648

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.004009	1000000	4059.13964844		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.284310	975000	287865.78125		
		Iron (Fe)	7439-89-6	0.006998	24000	7085.52197266		
		Phosphorus (P)	7723-14-0	0.000087	300	88.0880813599		
		Zinc (Zn)	7440-66-6	0.000204	700	206.551376343		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.291599	1000000	295245.9375		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.021727	1000000	21998.4921875		
		External Plating Total:				0.021727	1000000	21998.4921875
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.002333	1000000	2362.17822266		
Internal Plating Total:				0.002333	1000000	2362.17822266		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001110	750000	1123.88232422		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000370	250000	374.627471924		
Die Attach Total:				0.001480	1000000	1498.5098877		
Encapsulation	FILLED EPOXY RESIN	Resin (EP)		0.159840	240000	161839.078125		
		Bromine (Br)	40039-93-8	0.006660	10000	6743.29443359		
		Silica (SiO2)	60676-86-0	0.479520	720000	485517.21875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.019980	30000	20229.8847656		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000000	0	0		
		Encapsulation Total:				0.666000	1000000	674329.4375
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000500	1000000	506.253387451		
					TOTAL MASS (g) :	0.987648		